JOC341 Series

DESCRIPTION:

The products are gate driver opto-couplers in LSOP5 and LSOP5W packages. The device consists of an infrared LED optically coupled to an integrated high-gain, high-speed photodetector IC chip. It provides guaranteed performance and specifications at temperature up to 110 . It is physically smaller and compliant with international safety standards for reinforced insulation. It thus provides a smaller footprint solution for applications that require safety standard certification. An internal noise shield provides a guaranteed common-mode transient immunity of ±35 kV/μs. It is ideal for small class IGBT and power MOSFET gate drive. The products are widely used in industrial inverters, IGBT gate drivers, MOSFET gate drivers, induction cooktop and home appliances.

MAIN FEATURES

3A maximum peak output current
High isolation 5000 VRMS
Buffer logic type
Operating temperature range -40°C to 110°C
REACH & RoHS compliance
HBM: H3A; MM: M4; CDM: C3
CQC approved
VDE approved
UL approved

Truth Table

LED	V_{CC}-V_{EE} (Positive Going)	V_{CC}-V_{EE} (Negative Going)	Output
OFF	0-30V	0-30V	Low
ON	0-12.1V	0-11.1V	Low
ON	12.1V-13.5V	11.1V-12.4V	TRANSITION
ON	13.5V-30V	12.4V-30V	HIGH

ABSOLUTE MAXIMUM RATINGS (Temperature=25°C)

Parameter		Symbol	Value	Unit
LED	Forward Current	I_F	50	mA
	Peak Forward Current	I_{FP}	1	A
	Reverse Voltage	V_R	6	V
	Power Dissipation	P_D	100	mW
Detector	Output Voltage	V_O	35	V
	Supply Voltage	V_{CC}	35	V
	Power Dissipation	P_C	400	mW
Isolation Voltage		V_{iso}	5000	Vrms
Operating Temperature		T_{opr}	-40~110	
Junction Temperature		T_j	125	
Storage Temperature		T_{stg}	-55~125	
Total Power Dissipation		P_{tot}	500	mW
Soldering Temperature		T_{sol}	260	

NOTE1 100μs pulse, 100Hz frequency

NOTE2 AC for 1minute, R.H.=40~60%

ELECTRICAL CHARACTERISTICS (Temperature=25°C)

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit
Input	Forward Voltage	V_F	I_F=10mA	-	1.35	1.6	V
	Reverse Current	I_R	V_R=6V	-	-	1	μA
	Terminal Capacitance	C_t	V=0,f=1MHz	-	60	-	pF
Output	Peak High-level Output Current	I_{OPH}	V_O=V_{CC}-4V, Pulse width≤50μs	-1	-	-	A
			V_O=V_{CC}-15V, Pulse width≤10μs	-3	-	-	A
	Peak Low-level Output Current	I_{OPL}	V_O=V_{EE}+2.5V, Pulse width≤50μs	1	-	-	A
			V_O=V_{EE}+15V, Pulse width≤10μs	3	-	-	A
	High Level Supply Current	I_{CCH}	I_F=10mA V_{CC}=30V, V_O=Open	-	1.2	2	mA
	Low Level Supply Current	I_{CCL}	I_F=0mA , V_{CC}=30V, V_O=Open	-	1.1	2	mA

-0.3	V_{CC}-0.2	-	V
-	-	0.2	V
-	1.2	5	mA
.8	-	-	V
5	-	30	V
.1	12.8	13.5	V
.1	11.8	12.4	V

.	Typ.	Max.	Unit
	-	200	ns
	-	200	
	-	70	
0	-	100	
	50	-	

Recommended Operating Conditions

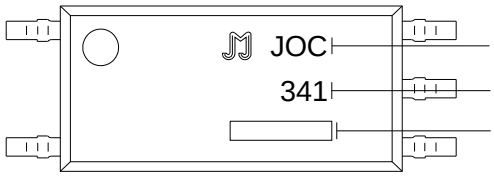
Characteristics	Symbol	Min.	Typ.	Max.	Unit
Input On-state Current	$I_{F(ON)}$	7	-	10	mA
Input Off-state Voltage	$V_{F(OFF)}$	0	-	0.8	V
Supply Voltage	V_{CC}	15	-	30	V
Operating Frequency	f	-	-	50	kHz

Note1: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.

Note2: Aceramic capacitor(0.1μF) should be connected betv d ś ŏ ˬ d Ï

ORDERING AND MARKING INFORMATION

MARKING INFORMATION



: Company Abbr.
: Part Number & Rank
: Production Information Code

Packing Quantity

Option	Quantity	Quantity – Inner box	Quantity –Outer box
LSOP5	3000 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box =30k Units
LSOP5W	1200 Units/Reel	2 Reels/Inner box	5 Inner box/Outer box =12k Units

Characteristics Curves

FIG.1: Forward Current vs. Forward Voltage

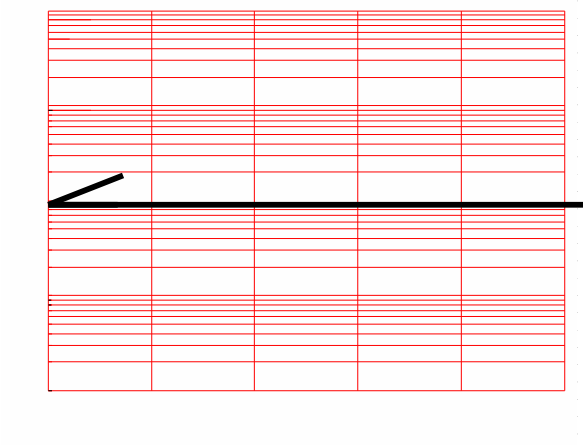
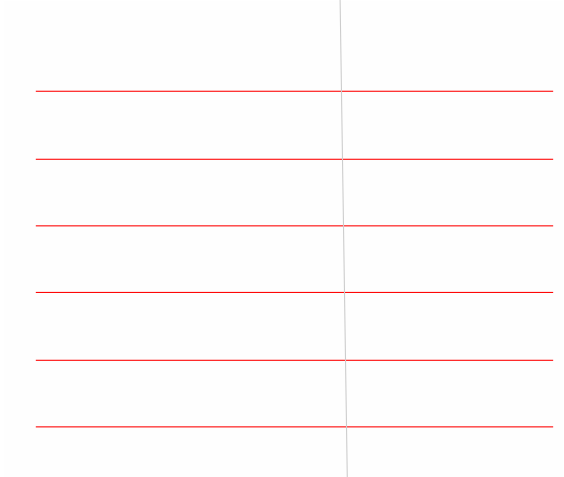


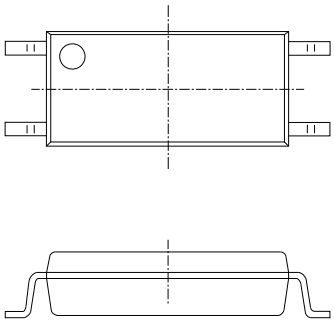
FIG.2: Max. Allowable LED Forward Current vs. Ambient Temperature

FIG.13: Propagation Delay Time vs. Supply Voltage



Package Dimension (Unit: mm)

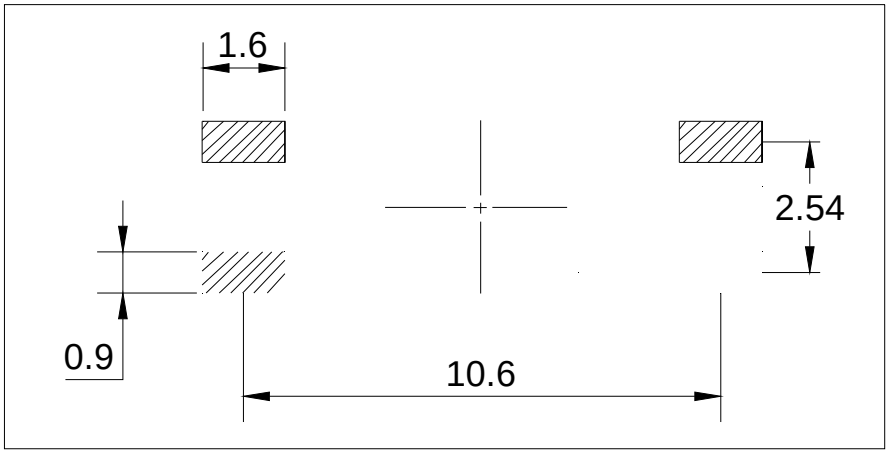
LSOP5



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	7.40		7.80	0.291		0.307
B	3.40		3.80	0.134		0.150
C	0.00		0.20	0.000		0.008
D	1.80		2.20	0.071		0.087
E	8.10		8.70	0.319		0.343
F	0.40		1.00	0.016		0.039
G	9.90		10.50	0.390		0.413
H	0.10		0.30	0.004		0.012
I	1.80		2.40	0.071		0.094
J	0.25		0.55	0.010		0.022
K						

RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)

LSOP5



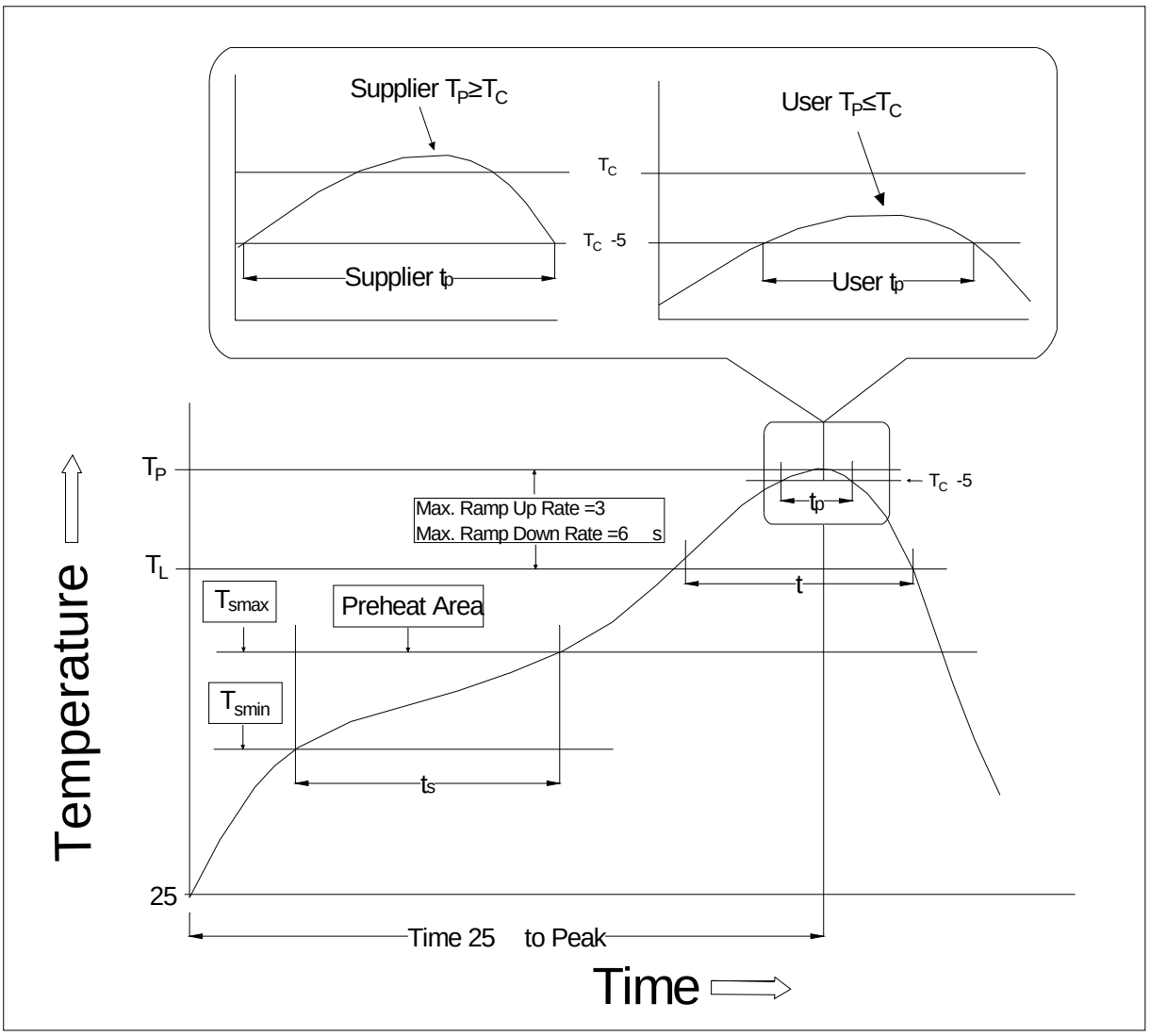
CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

LSOP5

Option T1

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
D0		1.55	1.60		0.061	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90		8.10	0.311		0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.20.311	0.299
T	0.35	0.40	0.45	0.014		0.018
W	15.80	16.00	16.20	0.622	0.630	0.638

REFLOW INFORMATION



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150
Temperature Max. (Tsmax)	150	200
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3 /second max.	3 /second max.
Liquidus Temperature (TL)	183	217
Time (tL) Maintained Above (TL)	60-150 seconds	60-150 seconds
Peak Body Package Temperature	235 +0 /-5	260 +0 /-5
Time (tP) within 5 of 260	10 seconds	10 seconds
Ramp-down Rate (TP to TL)	3-6 /second	3-6 /second
Time 25 to Peak Temperature	6 minutes max.	8 minutes max.

Note:

1. Reflow soldering is recommended at the temperatures and times shown, no more than three times.

2. Avoid direct contact between the epoxy body and any tools or surfaces exceeding its maximum storage temperature.

3. Application of pressure on the epoxy body is prohibited at elevated temperatures. In specific scenarios, any applied force must not exceed 2.5N.

4. Ensure the component has cooled to ambient temperature before proceeding with any subsequent manufacturing steps. atu ª ' M D l א ﬣ M ק נ ﬠ " ᴀ D ק r ϟ " !